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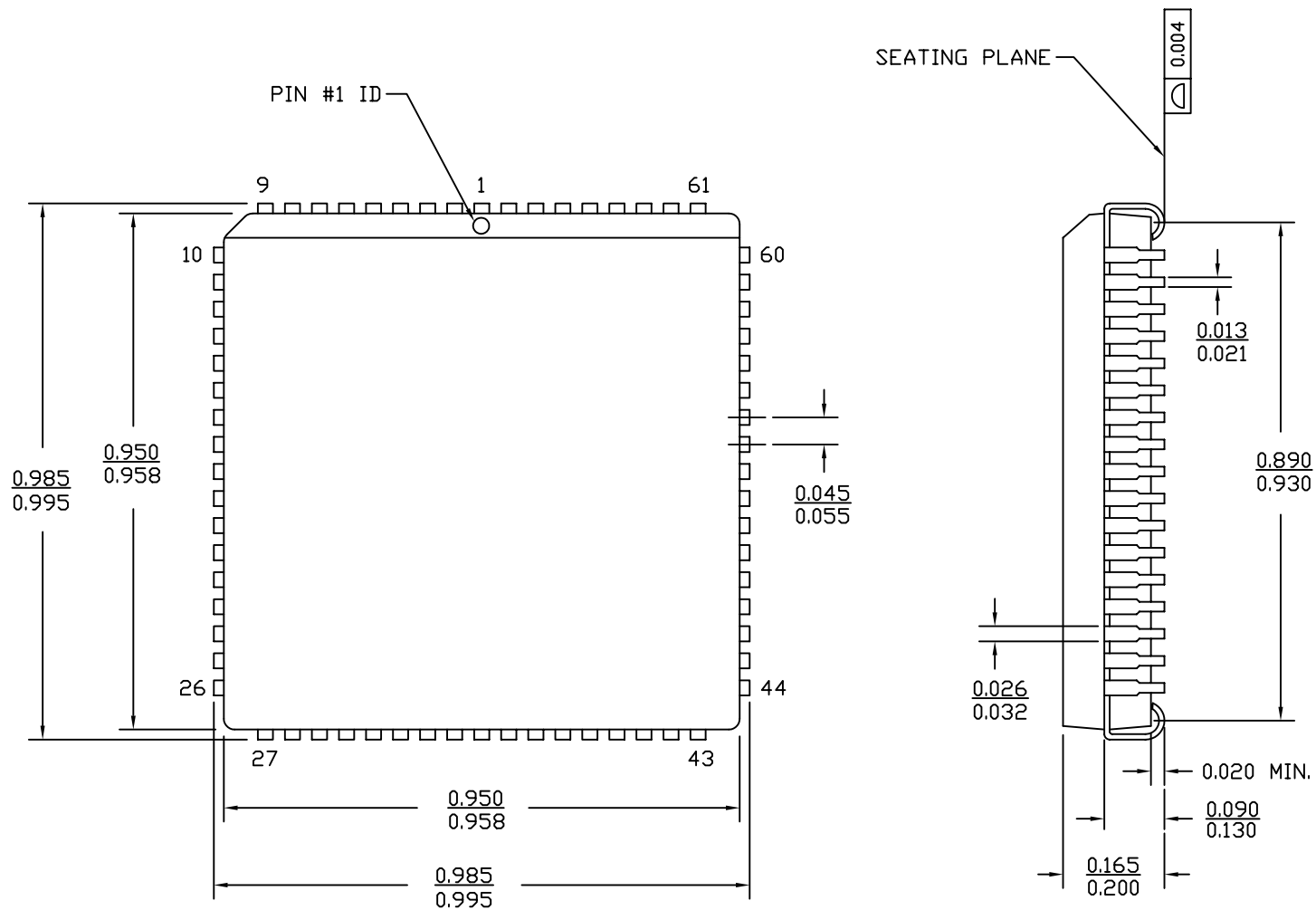
**Continuity of document content**

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**Continuity of ordering part numbers**

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

# 68 Lead Plastic Leaded Chip Carrier J81



DIMENSIONS IN INCHES MIN.  
MAX.

 <b>CYPRESS</b> Company Confidential	
TITLE PACKAGE OUTLINE, 68L PLCC .958X.958 INCHES J68	
SPEC NO. 51-85005	REV *D
SCALE	SHEET 1 OF 2

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PACKAGE  
CODE(S)

REVISIONS						
PAGE	ZONE	REV	ECN	DESCRIPTION	DATE	APPROVED
1	—	**	N/A	N/A	N/A	N/A
1	—	*A	49364	ADD LEAD COPLANARITY, CHG. TITLE	04/01/97	HTN
ALL	—	*B	2868863	CHANGED TEMPLATE, CHANGE TITLE FROM 68LD PLCC PACKAGE OUTLINE TO PACKAGE OUTLINE, 68L PLCC .958X.958 INCHES J68	04/01/97	QAD
ALL	—	*C	3278135	No Change. Sunset Review.	06/09/11	N/A
ALL	—	*D	4593751	Sunset Review, Changed drawing template.	12/11/14	QAD